

L Number	Hits	Search Text	DB	Time stamp
-	1660	29/832.ccls.	USPAT; JPO; DERWENT	2003/05/21 15:58
-	4526	29/831,832,846,854,876,877.ccls.	USPAT; JPO; DERWENT	2003/05/21 16:01
-	1	("6507989").PN.	USPAT; JPO; DERWENT	2003/05/21 16:00
-	3442	29/831,832,592.1.ccls.	USPAT; JPO; DERWENT	2003/05/21 16:10
-	5	("5075253" "5355577" "5545291" "5925259" "6001232").PN.	USPAT	2003/05/21 16:01
-	18	5545291.URPN.	USPAT	2003/05/21 16:02
-	16	("3439416" "3756872" "4111294" "4194668" "4542397" "4554611" "4802951" "4843035" "4907062" "4949148" "4962441" "4975143" "4990462" "5034802" "5063177" "5075253").PN.	USPAT	2003/05/21 16:08
-	3279	(self adj assembl\$3) or self-assembl\$3	USPAT; JPO; DERWENT	2003/05/21 16:23
-	5	29/831,832,592.1.ccls. and ((self adj assembl\$3) or self-assembl\$3)	USPAT; JPO; DERWENT	2003/05/21 16:11
-	11	("4016456" "4956065" "5008043" "5196212" "5755944" "5894367" "5975680" "6074442" "6107038" "6190509" "6197176").PN.	USPAT	2003/05/21 16:12
-	811	(self adj assembl\$3) or self-assembl\$3	JPO; DERWENT	2003/05/21 16:24
-	4	((self adj assembl\$3) or self-assembl\$3) and (electrical adj circuit)	USPAT; JPO; DERWENT	2003/05/21 16:26
-	1	(((self adj assembl\$3) or self-assembl\$3) and (electrical adj circuit)) and non-planar	USPAT; JPO; DERWENT	2003/05/21 16:29
-	1	(((self adj assembl\$3) or self-assembl\$3) and (electrical adj circuit)) and molecular	USPAT; JPO; DERWENT	2003/05/21 16:30
-	0	(((self adj assembl\$3) or self-assembl\$3) and (electrical adj circuit)) and fluide	USPAT; JPO; DERWENT	2003/05/21 16:28
-	0	(((self adj assembl\$3) or self-assembl\$3) and (electrical adj circuit)) and fluid	USPAT; JPO; DERWENT	2003/05/21 16:30
-	0	(((self adj assembl\$3) or self-assembl\$3) and (electrical adj circuit)) and (electrical adj conductor)	USPAT; JPO; DERWENT	2003/05/21 16:30
-	0	(((self adj assembl\$3) or self-assembl\$3) and (electrical adj circuit)) and 3-D	USPAT; JPO; DERWENT	2003/05/21 16:29
-	156	((self adj assembl\$3) or self-assembl\$3) and molecular	USPAT; JPO; DERWENT	2003/05/21 16:30
-	8	((self adj assembl\$3) or self-assembl\$3) and non-planar	USPAT; JPO; DERWENT	2003/05/21 16:30
-	3	((self adj assembl\$3) or self-assembl\$3) and (electrical adj conductor)	USPAT; JPO; DERWENT	2003/05/21 16:33
-	37	((self adj assembl\$3) or self-assembl\$3) and fluid	USPAT; JPO; DERWENT	2003/05/21 16:34
-	1	(US-6507989-\$).did.	USPAT	2003/05/23 14:13
-	1	((US-6507989-\$).did.) and interaction	USPAT; JPO; DERWENT	2003/05/23 14:17

-	1	((US-6507989-\$).did.) and fluid	USPAT; JPO; DERWENT	2003/05/23 14:20
-	1	((US-6507989-\$).did.) and reversible	USPAT; JPO; DERWENT	2003/05/23 14:21
-	1	((US-6507989-\$).did.) and (reversible and irreversible)	USPAT; JPO; DERWENT	2003/05/23 14:21

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(self assembly) and fluid

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1 Fluidic self-assembly of microstructures and its application to the integration of GaAs on Si

Hsi-Jen Yeh; Smith, J.S.;

Micro Electro Mechanical Systems, 1994, MEMS '94, Proceedings, IEEE Workshop on, 1994

Page(s): 279 -284

[\[Abstract\]](#) [\[PDF Full-Text \(444 KB\)\]](#) **IEEE CNF**

2 Fluidic self-assembly for the integration of GaAs light-emitting diodes on Si substrates

Yeh, H.-J.J.; Smith, J.S.;

IEEE Photonics Technology Letters, Volume: 6 Issue: 6 , Jun 1994

Page(s): 706 -708

[\[Abstract\]](#) [\[PDF Full-Text \(264 KB\)\]](#) **IEEE JNL**

3 Chemical functionalization of nanostructured materials using supercritical reaction media

Zemanian, T.S.; Fryxell, G.E.; Jun Liu; Mattigod, S.; Yongsoon Shin;

Franz, J.A.; Ustyugov, O.; Zimin Nie;

Nanotechnology, 2001. IEEE-NANO 2001. Proceedings of the 2001

1st IEEE Conference on, 2001

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[\[Abstract\]](#) [\[PDF Full-Text \(305 KB\)\]](#) **IEEE CNF**

4 Self-assembly in model magnetic inks

Visscher, P.B.; Gunal, Y.;
Magnetics, IEEE Transactions on, Volume: 34 Issue: 4, Jul 1998
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